

“War, Peace, and Prosperity: The Future of Globalization”

An Economics Research Conference on International Trade
and International Macroeconomics in Shenzhen, China

Call for Papers



China reopened from COVID to a world economy that is different from the past. In a world with escalating conflicts, increasing tensions, and the imposition of sanctions, the risks of geopolitical fragmentations are growing. This evolving scenario raises a critical question: Will the era of international integration and shared prosperity, which significantly contributed to China's rise from poverty, continue to thrive?

With these questions and concerns, we at the Chinese University of Hong Kong Shenzhen and the HKU Business School Shenzhen Research Institutes (SZRI) are organizing a research conference on international trade/macroeconomics. This conference will focus on examining the economic forces behind the current trends in globalization.

We are particularly interested in exploring the potential consequences of evolving policies, emerging technologies, shifts in the flows of goods and capital, climate change, and other transformations in economic fundamentals on future international trade and investment. **We sincerely invite economists from around the world to submit your best papers on these topics.**

The two-day conference will take place in **Shenzhen**, China, a neighboring city to Hong Kong, on **April 13-14, 2024**. Shenzhen is a vibrant city that has grown from a fishing village into an economic powerhouse, hosting advanced Chinese companies such as Tencent and DJI, thanks to China's Reform and Opening Up policies.

Keynote Speakers

Carsten Eckel (Professor and Chair of International Economics, Ludwig-Maximilians-Universität München)

Kim Ruhl (Curt and Sue Culver Professor of Economics, University of Wisconsin – Madison)

We expect to invite additional keynote speakers.

Submission

Please submit your paper to **iejc_sz@cuhk.edu.cn**. In the email subject line, kindly write, **“Submission for International Economics Conference in Shenzhen”**. Within the email body, please provide the name of the presenter and their city of departure. The deadline for submission is **February 1, 2024**. We will contact accepted authors by February 10. Due to the number of submissions, we will not be able to contact authors who will not be on the program.

For each accepted paper, we can reimburse one presenter's travel expenses up to **USD\$1,500** for those traveling from outside Asia, and up to **USD\$500** for those traveling within Asia, covering either flight or train tickets. Additionally, we will provide accommodations for three nights in Shenzhen, China.

A dedicated team from the Chinese University of Hong Kong Shenzhen will assist visitors with obtaining Chinese visas (if required) and managing local logistics.

Organizers

Haishi “Harry” Li (University of Hong Kong)

Jian Wang (Chinese University of Hong Kong Shenzhen)

Haichun Ye (Chinese University of Hong Kong Shenzhen)

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We look forward to hosting you in Shenzhen. If you have questions, please contact us.